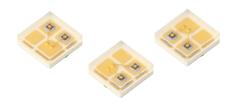


APGF0606SEEKSYKXC-TT

0.65 x 0.65 x 0.2 mm Bi-Color Surface Mount LED



DESCRIPTIONS

- The Hyper-Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Super Bright Yellow source color devices are made with AlGaInP on GaAs substrate Light Emitting
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65mm SMD LED, 0.2 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- RoHS compliant

APPLICATIONS

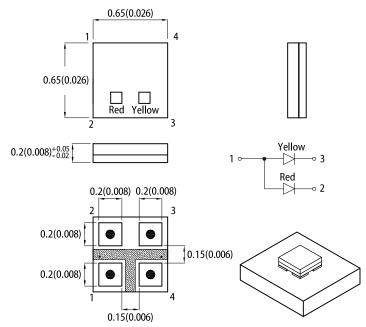
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

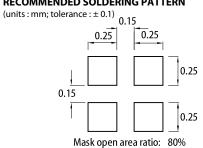
Observe precautions for handling electrostatic discharge sensitive devices



PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to

Mask thickness: 80~100um

- change without prior notice.

 The device has a single mounting surface. The device must be mounted according to the specifications

SELECTION GUIDE

Don't Name to as	Emitting Color	T	Iv (mcd) @ 5mA [2]		Viewing Angle [1]
Part Number	(Material)	Lens Type	Min.	Тур.	201/2
APGF0606SEEKSYKXC-TT	■ Hyper Red (AlGalnP)	Water Clear	30 80	80	4400
APGF0000SEEKSYKXC-TT	Super Bright Yellow (AlGaInP)		10	17	140°

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.



ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Farittina Colon	Value		l lmi4
Parameter		Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 5mA	λ_{peak}	Hyper Red Super Bright Yellow	632 591	-	nm
Dominant Wavelength I _F = 5mA	λ _{dom} ^[1]	Hyper Red Super Bright Yellow	624 589	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 5mA	Δλ	Hyper Red Super Bright Yellow	20 15	-	nm
Capacitance	С	Hyper Red Super Bright Yellow	25 25	-	pF
Forward Voltage I _F = 5mA	V _F ^[2]	Hyper Red Super Bright Yellow	1.95 1.97	2.3 2.3	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Super Bright Yellow	-	10 10	μΑ

Notes:

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Davanadas		Va			
Parameter	Symbol	Hyper Red	Super Bright Yellow	Unit	
Power Dissipation	P _D [1]	3	mW		
Reverse Voltage	V_R	5	5	V	
Junction Temperature	Tj	115	115	°C	
Operating Temperature	T _{op}	-40 to	°C		
Storage Temperature	T _{stg}	-40 to +100		°C	
DC Forward Current	I _F ^[2]	10	10	mA	
Peak Forward Current	I _{FM} ^[3]	50	50	mA	
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V	

Notes:

1. The dominant wavelength (\(\lambda\)d) above is the setup value of the sorting machine. (Tolerance \(\lambda\)d: \(\pm 1nm.\))

2. Forward voltage: \(\pm 2.1V.\)

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and \(\rangle\) or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Notes:

1. Within 35mW when multiple chips are lightened

2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings

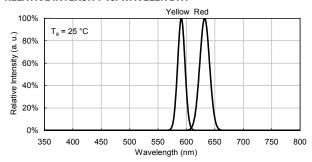
3. Duty Cycle ≤ 1 / 20. Pulse Width = 1ms.

4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity − Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

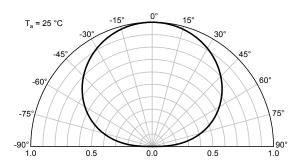


TECHNICAL DATA

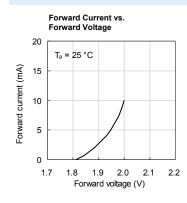
RELATIVE INTENSITY vs. WAVELENGTH

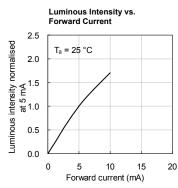


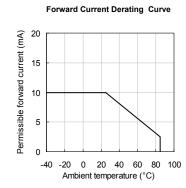
SPATIAL DISTRIBUTION

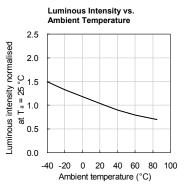


HYPER RED

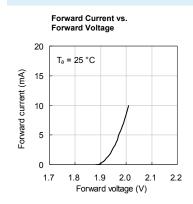


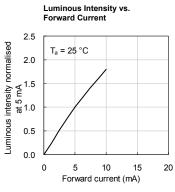


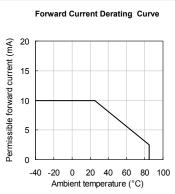


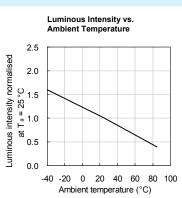


SUPER BRIGHT YELLOW









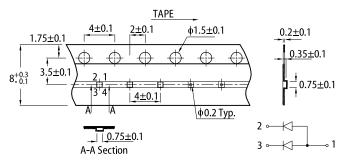


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

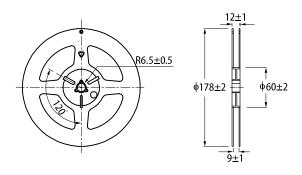
300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max. 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 0 0 100 150 200 250 (sec) Time

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

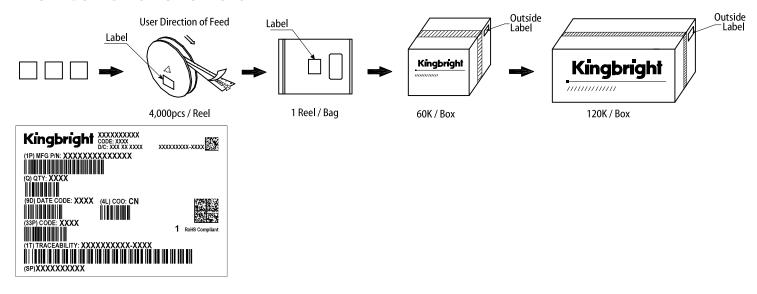
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright. All design applications should refer to Kingbright application notes available at https://www.KingbrightUSA.com/Application

